

## 1.06 Gbps LVDS Buffer / Repeater (DS10BR150) Evaluation Kit

# USER MANUAL

Part Number: DS10BR150EVK NOPB

For the latest documents concerning these products and evaluation kit, visit lvds.national.com. Schematics and gerber files are also available at lvds.national.com.

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#### Overview

The DS10BR150EVK is an evaluation kit designed for demonstrating performance of the 1.06 Gbps LVDS Buffer / Repeater (DS10BR150).

The purpose of this document is to: familiarize you with the DS10BR150EVK, suggest the test setup procedures and instrumentation, and guide you through some typical measurements that demonstrate performance of the device in typical applications.

#### **DS10BR150EVK Description**

Figure 1 shows the top layer drawing of the PCB with the silkscreen annotations. It is a small six-layer PCB that has a single-device layout capable of demonstrating performance and all features of the DS10BR150.



Figure 1. DS10BR150EVK

#### **DS10BR150** Evaluation

This section provides recommended test setup procedure for the device evaluation. Figure 2 depicts a typical setup and instrumentation you may use for the device evaluation.

- 1. Apply the power to the device (3.3V typical) between VDD2 and GND connectors.
- 2. Connect a signal source (i.e. signal generator or an LVDS driver) to the input (R1 label) on the board and adjust the signal parameters (VOH, VOL, VCM) so that they comply with the device input recommendations.
- 3. Connect the output (U1 label) to an oscilloscope and view the output signals with an oscilloscope that has the bandwidth of at least 3 GHz.

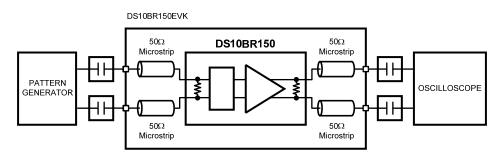


Figure 2. DS10BR150 Test Setup Example

#### **Typical Performance**

This section of the User Manual shows a typical eye diagram you can expect to see when evaluating the DS10BR150EVK.

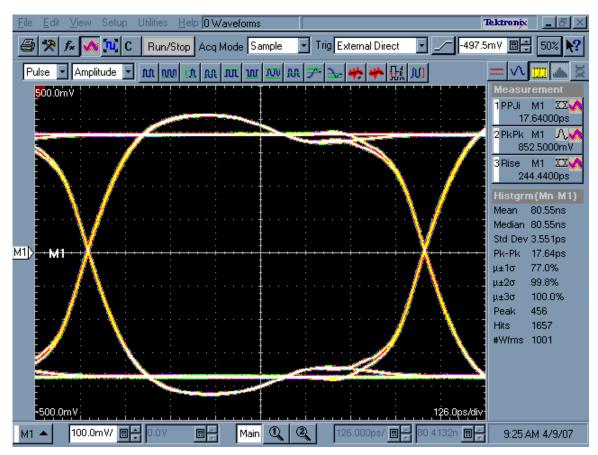
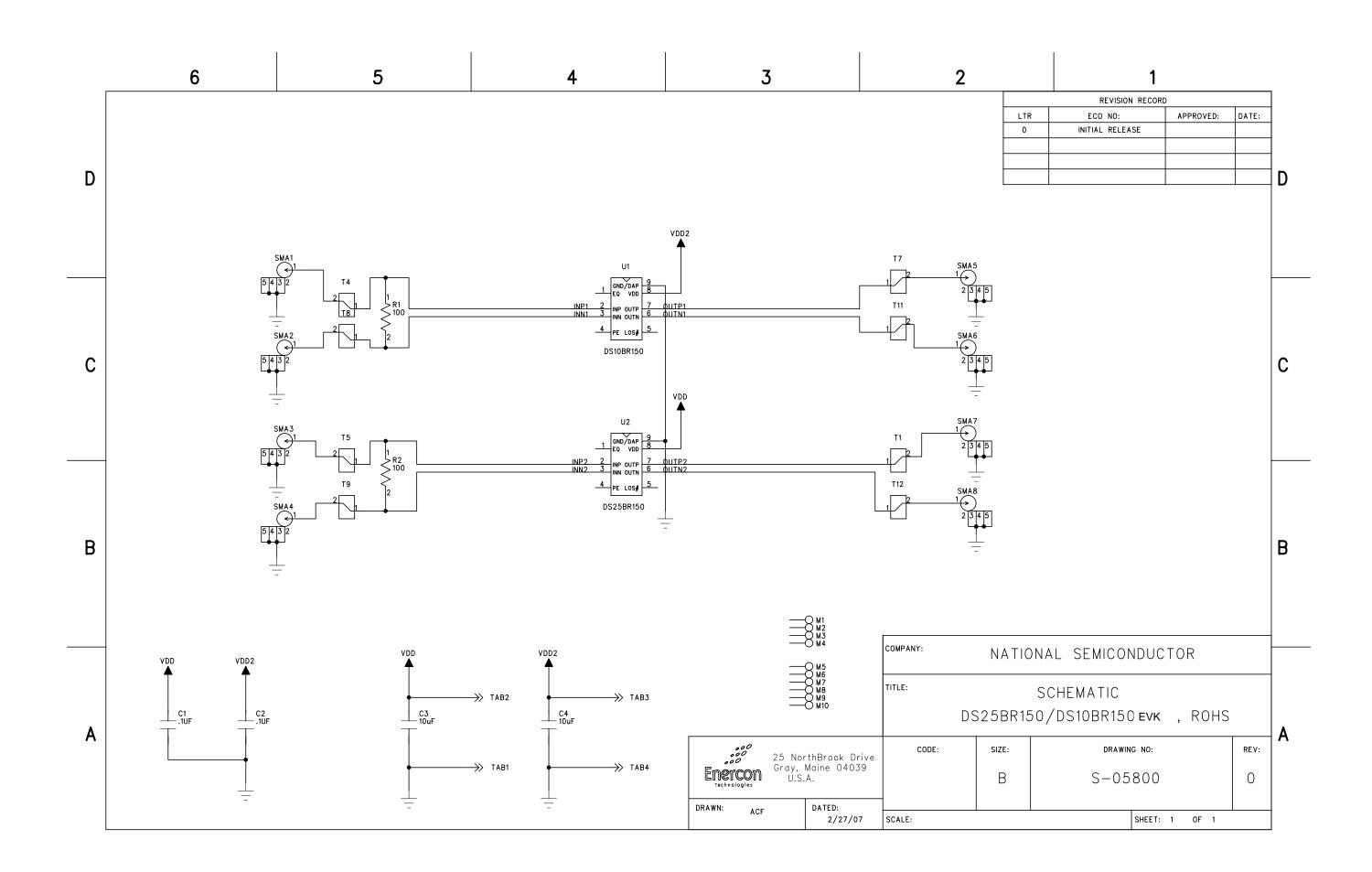


Figure 2. DS10BR150 1.06 Gbps PRBS-7 Output Eye Diagram



ENERCON - BILL OF MATERIALS Main Product: PCBA, DS10BR150 EVK			TERIALS				Numbe 054-	r: Rev: F •01 0	ev By: Rev Date: 2/27/2007		PL Status: Release	PL Status: Released	
				PCBA, DS10BR150EVK, ROHS		Res				Creator: Arlene Fox		Creation Date: 2/27/2007	
ltem	Part Type	Part Number/Value	Mfg	NoSub	Description	Qty	SMT	Re	ef Des		Notes	Rev	
1	PCB	P-05797R0			DS10/25BR150K: 1.25x2.03x.060in, 6 layer	1				Bd: (3 51.43m		0	
2													
	IC	DS10BR150	NAT			1		Ul		CUSTOM SUPPLI		0	
4	CAP	0402YD104KAT	AVX		.1µF, 16V, ±10%, 0402, Ceramic, X5R, Pb-	1	x	C2				0	
					Free								
	<alt></alt>	ECJ-0EB1C104K	PANA		.1µF, 16V, ±10%, 0402, Ceramic, X5R, Pb-Free								
6	CAP	ECJ-3YB0J106K	PANA		10μF, 6.3V, ±10%, 1206, Ceramic, X5R, Pb-Free	1	X	C4				0	
	<alt></alt>	12066D106KAT	AVX		10μF, 6.3V, ±10%, 1206, Ceramic, X5R, Pb-Free								
	<alt></alt>	C1206C106K9PAC	KEMET		10μF, 6.3V, ±10%, 1206, Ceramic, X5R, Pb-Free								
7												0	
8	CONN	1287-ST	KEYSTONE		Faston, Male, .250x.032, Pb-Free	2		TAB1,3		VDD2,	GND	0	
9	CONN	142-0701-851	EMERSON		SMA, Jack Receptacle, 50 OHM, Pb-Free	4	:	SMA1,2,	5,б			0	
10													
11	STENCL	T-05801R1	ENERCON		STENCIL FABRICATION, TOP, DS25BR150/DS10BR150 EVK	1						0	
12	STENCL	T-05802R1	ENERCON		STENCIL FABRICATION, BOTTOM, DS25BR150/DS10BR15	1						0	
13													
14	REF	C-05798R0	ENERCON		FABRICATION DWG, DS25BR150/DS10BR150 EVK, ROHS							0	
15	REF	C-05799R1	ENERCON		PALLET DWG, DS25BR150/DS10BR150 EVK							0	
16	REF	S-05800R0	ENERCON		SCHEMATIC, DS25BR150/DS10BR150 EVK							0	
17										1			

ENERCON - BILL OF MATERIALS	PL Number: Rev: 1 Z3054-01 0	Rev By: Rev Date: 2/27/2007	PL Status: Released
Main Product: PCBA, DS10BR150 EVK	Responsible Eng/Mgr:	Creator: Arlene Fox	Creation Date: 2/27/2007

Notes:

DO NOT STUFF:

R1,2 U2 C1,3 TAB2 SMA3,4,7,8

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